



LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent No.</u>	<u>Filing or Issue Date</u>	<u>Status or Patentee</u>
MB 213700US2 RD	09/947,355	09/07/01	PENDING
MB 215231US2 RD*	09/981,987	10/19/01	PENDING
MB 219138US2 SRD	10/060,247	02/01/02	PENDING
MB 224536US2 TFCRD	10/175,960	06/21/02	PENDING
MB 224586US2 TFCRD	10/178,023	06/24/02	PENDING
MB 226953US6 RD	10/217,410	08/14/02	PENDING

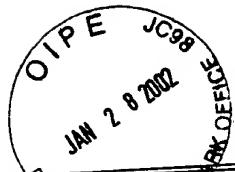
MB 22 11/19/03

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*Present application; listed for information

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SHEET 1 OF 1

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(Modified)U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY DOCKET NO.
215231US2RDSERIAL NO.
09/981,987

LIST OF REFERENCES CITED BY APPLICANT

APPLICANT
Yuuzo KAMIGUCHI, et al.FILING DATE
October 19, 2001GROUP
2651

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	6,303,218	10/16/2001	Y. KAMIGUCHI, et al.			
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

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FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES	NO
	AO					
	AP					
	AQ					
	AR					
	AS					
	AT					
	AU					
	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

MSB	AW	K. NAGASAKA, et al., The 8th Joint MMM-Intermag Conference, Abstracts, page 214, DD-10, "GIANT MAGNETORESISTANCE PROPERTIES OF SPECULAR SPIN VALVE FILMS IN CPP STRUCTURE", January 7-11, 2001
MSB	AX	K. NAGASAKA, et al., Journal of the Magnetic Society of Japan, vol. 25, no. 4-2, pages 807-810, "GIANT MAGNETORESISTANCE PROPERTIES OF SPIN VALVE FILMS IN CURRENT-PERPENDICULAR-TO-PLANE GEOMETRY", 2001 (with English Abstract)
	AY	
	AZ	

Examiner

Date Considered 11/12/03

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.